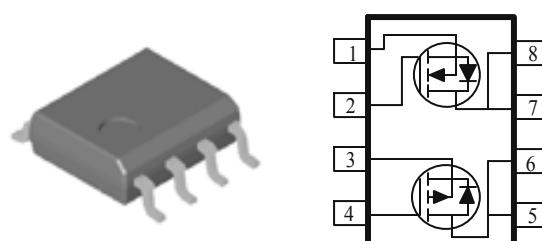


P & N-Channel 30-V (D-S) MOSFET

These miniature surface mount MOSFETs utilize a high cell density trench process to provide low $r_{DS(on)}$ and to ensure minimal power loss and heat dissipation. Typical applications are DC-DC converters and power management in portable and battery-powered products such as computers, printers, PCMCIA cards, cellular and cordless telephones.

- Low $r_{DS(on)}$ provides higher efficiency and extends battery life
- Low thermal impedance copper leadframe SOIC-8 saves board space
- Fast switching speed
- High performance trench technology

PRODUCT SUMMARY		
V_{DS} (V)	$r_{DS(on)}$ m(Ω)	I_D (A)
30	82 @ $V_{GS} = 2.5V$	4.2
	58 @ $V_{GS} = 4.5V$	5.0
-26.5	172 @ $V_{GS} = -2.5V$	-2.9
	112 @ $V_{GS} = -4.5V$	-3.6



ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ UNLESS OTHERWISE NOTED)				
Parameter	Symbol	N-Channel	P-Channel	Units
Drain-Source Voltage	V_{DS}	30	-26.5	V
Gate-Source Voltage	V_{GS}	± 12	± 12	
Continuous Drain Current ^a	$T_A=25^\circ C$	I_D	5.0	A
	$T_A=70^\circ C$		4.1	
Pulsed Drain Current ^b	I_{DM}	20	-20	
Continuous Source Current (Diode Conduction) ^a	I_S	1.3	-1.3	A
Power Dissipation ^a	$T_A=25^\circ C$	P_D	2.1	W
	$T_A=70^\circ C$		1.3	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 150		°C

THERMAL RESISTANCE RATINGS				
Parameter	Symbol	Maximum	Units	
Maximum Junction-to-Ambient ^a	$R_{\theta JA}$	62.5	°C/W	
Steady-State		110	°C/W	

Notes

- Surface Mounted on 1" x 1" FR4 Board.
- Pulse width limited by maximum junction temperature

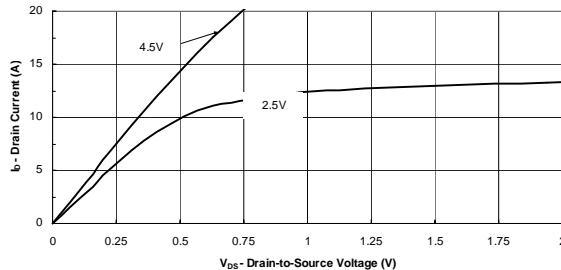
SPECIFICATIONS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)						
Parameter	Symbol	Test Conditions	Limits			
			Ch	Min	Typ	Max
Static						
Gate-Threshold Voltage	$V_{GS(\text{th})}$	$V_{GS} = V_{DS}, I_D = 250 \mu\text{A}$	N	0.6		
		$V_{GS} = V_{DS}, I_D = -250 \mu\text{A}$	P	-0.6		
Gate-Body Leakage	I_{GSS}	$V_{GS} = -12 \text{ V}, V_{DS} = 0 \text{ V}$	P		± 100	
		$V_{GS} = 12 \text{ V}, V_{DS} = 0 \text{ V}$	N		± 100	
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -24 \text{ V}, V_{GS} = 0 \text{ V}$	P		-1	
		$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$	N		1	
On-State Drain Current ^A	$I_{D(\text{on})}$	$V_{DS} = 5 \text{ V}, V_{GS} = 4.5 \text{ V}$	N	20		
		$V_{DS} = -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	P	-20		
Drain-Source On-Resistance ^A	$r_{DS(\text{on})}$	$V_{GS} = 4.5 \text{ V}, I_D = 5.0 \text{ A}$	N		58	
		$V_{GS} = 2.5 \text{ V}, I_D = 4.2 \text{ A}$			82	
		$V_{GS} = -4.5 \text{ V}, I_D = -3.6 \text{ A}$	P		112	
		$V_{GS} = -2.5 \text{ V}, I_D = -2.9 \text{ A}$			172	
Forward Tranconductance ^A	g_{fs}	$V_{DS} = 15 \text{ V}, I_D = 5.0 \text{ A}$	N		25	
		$V_{DS} = -15 \text{ V}, I_D = -3.6 \text{ A}$	P		10	
Dynamic						
Total Gate Charge	Q_g	N-Channel $V_{DS}=15\text{V}, V_{GS}=4.5\text{V}, I_D=5.0\text{A}$ P-Channel $V_{DS}=-15\text{V}, V_{GS}=-4.5\text{V}, I_D=-3.6\text{A}$	N		6.3	
Gate-Source Charge	Q_{gs}		P		10	
Gate-Drain Charge	Q_{gd}		N		0.9	
			P		2.2	
Switching						
Turn-On Delay Time	$t_{d(\text{on})}$	N-Chaneel $V_{DD}=15\text{V}, V_{GS}=4.5\text{V}, I_D=1\text{A}$, $R_{GEN}=6\Omega$, P-Channel $V_{DD}=-15\text{V}, V_{GS}=-4.5\text{V}, I_D=-1\text{A}$, $R_{GEN}=6\Omega$	N		7.4	
Rise Time	t_r		P		7.6	
Turn-Off Delay Time	$t_{d(\text{off})}$		N		4	
Fall-Time	t_f		P		6.8	
			N		22.2	
			P		33.6	
			N		3.6	
			P		23.2	

Notes

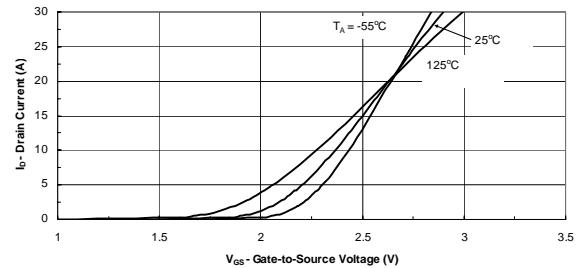
- a. Pulse test: PW <= 300us duty cycle <= 2%.
- b. Guaranteed by design, not subject to production testing.

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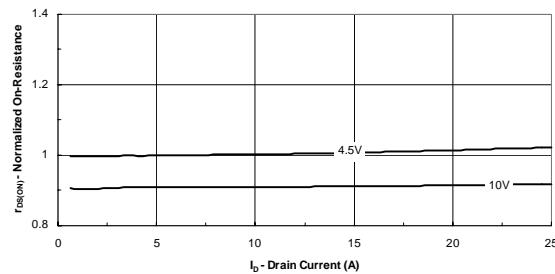
Typical Electrical Characteristics (N-Channel)



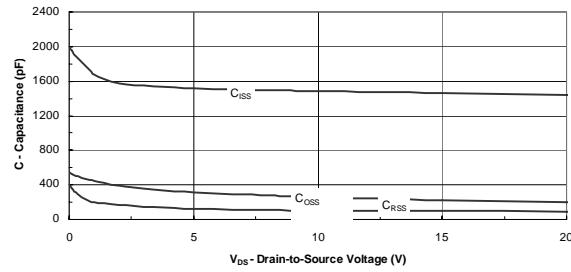
Output Characteristics



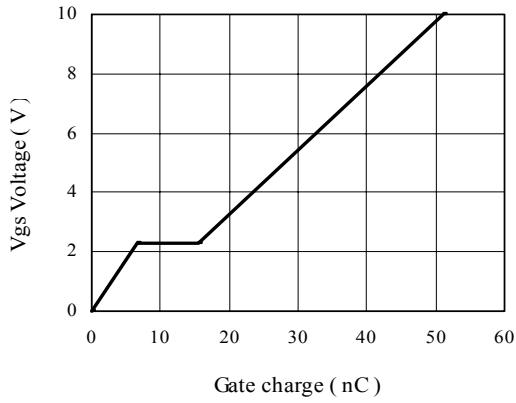
Transfer Characteristics



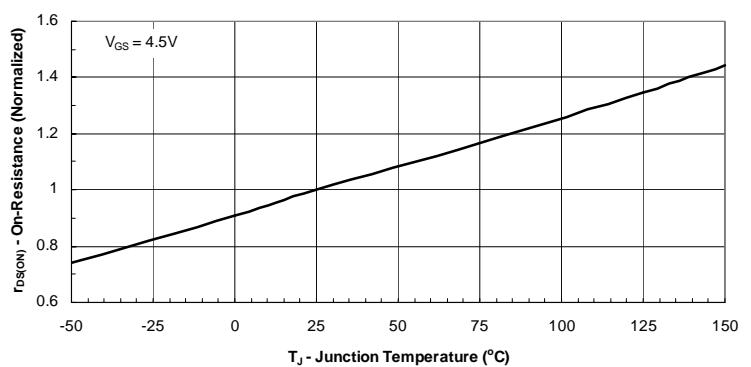
On-Resistance vs. Drain Current



Capacitance

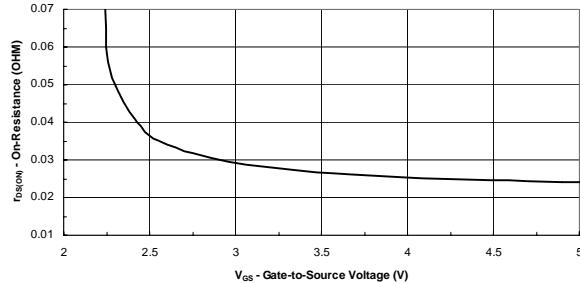
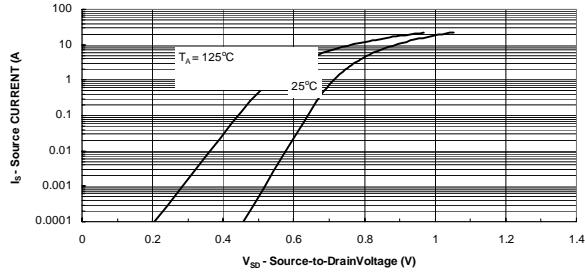


Gate Charge

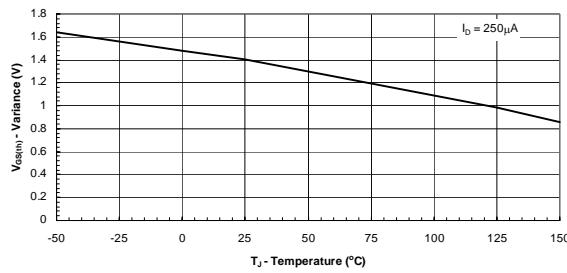


On-Resistance vs. Junction Temperature

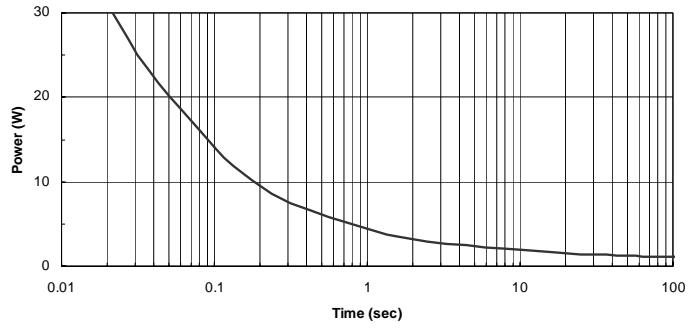
Typical Electrical Characteristics (N-Channel)



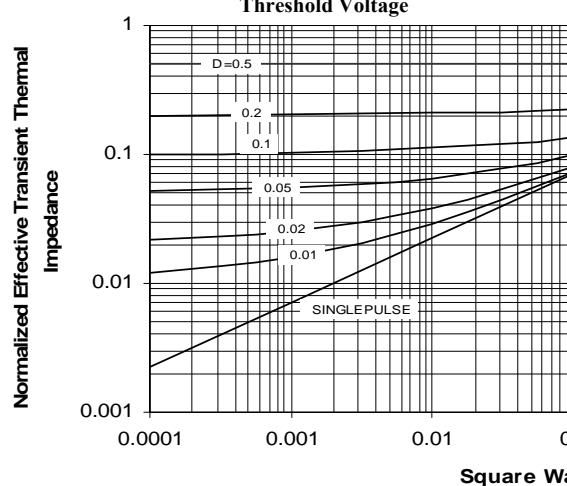
Source-Drain Diode Forward Voltage



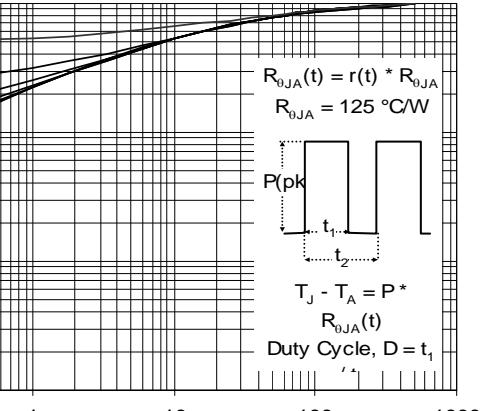
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

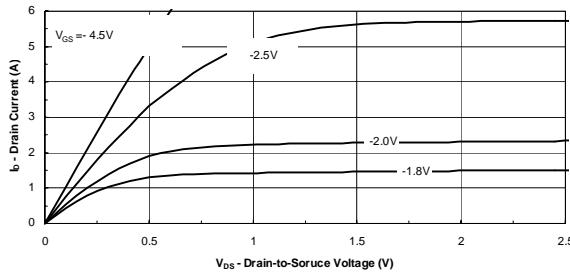


Single Pulse Power

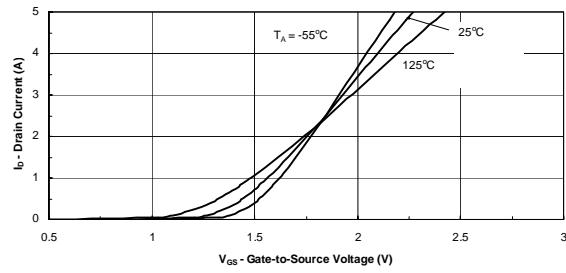


Normalized Thermal Transient Impedance, Junction-to-Ambient

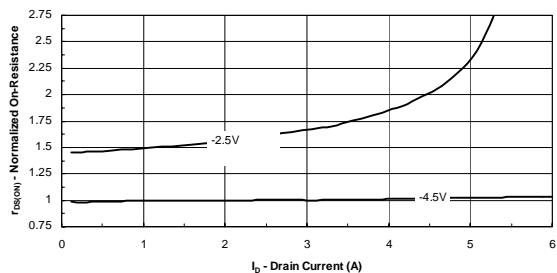
Typical Electrical Characteristics (P-Channel)



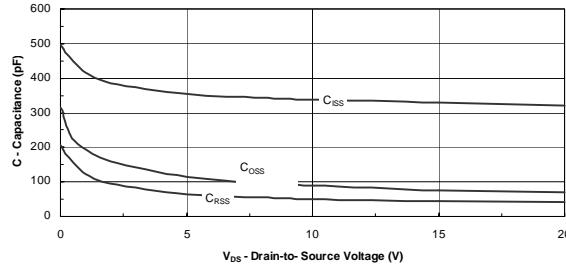
Output Characteristics



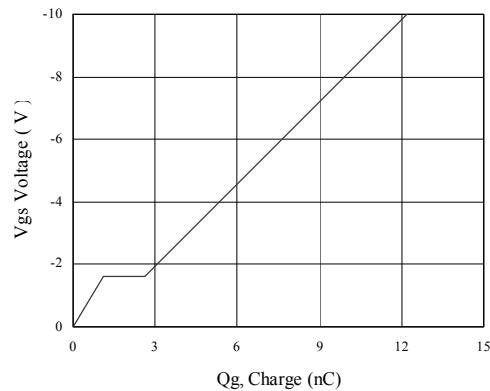
Transfer Characteristics



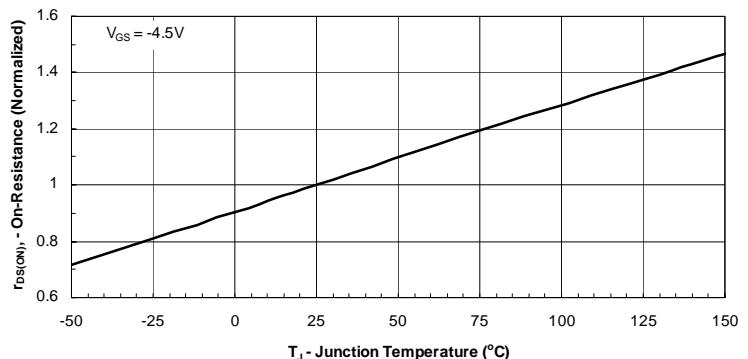
On-Resistance vs. Drain Current



Capacitance

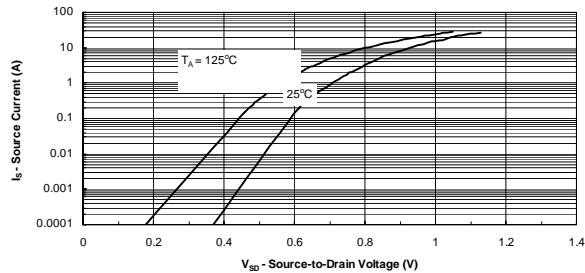


Gate Charge

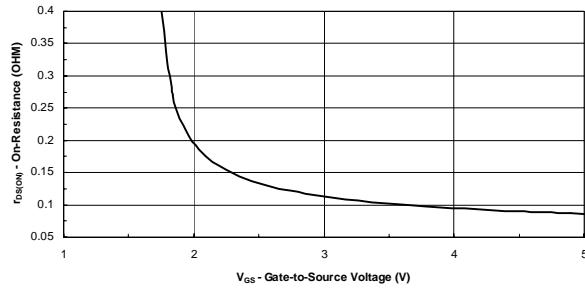


On-Resistance vs. Junction Temperature

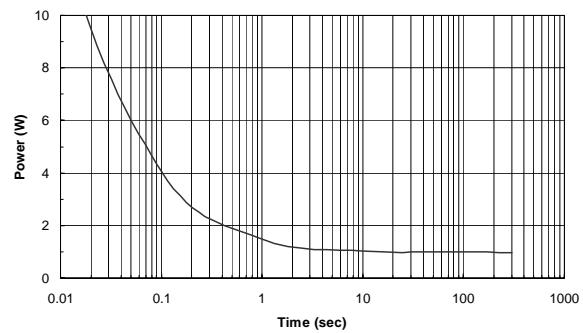
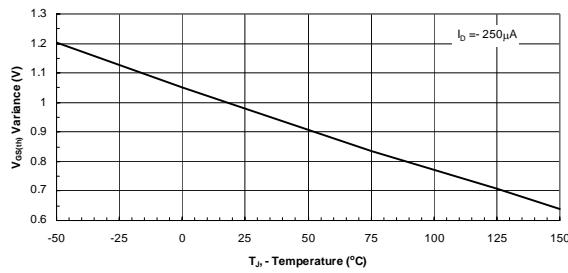
Typical Electrical Characteristics (P-Channel)



Source-Drain Diode Forward Voltage

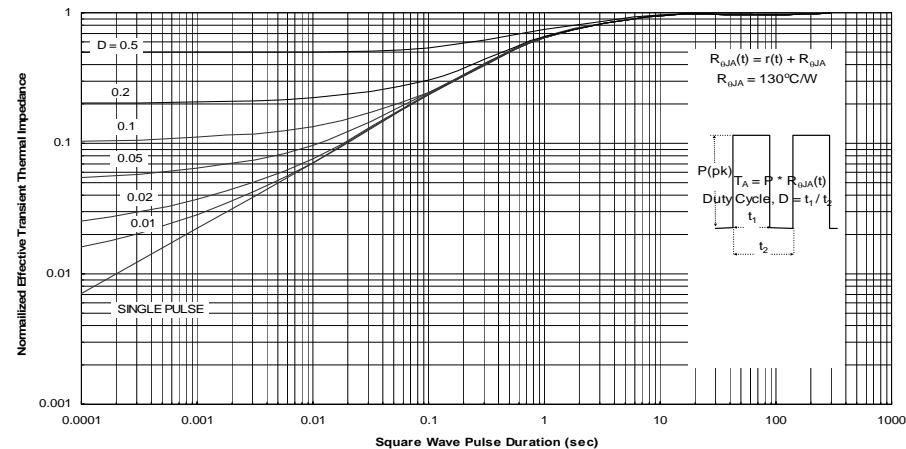


On-Resistance vs. Gate-to Source Voltage



Threshold Voltage

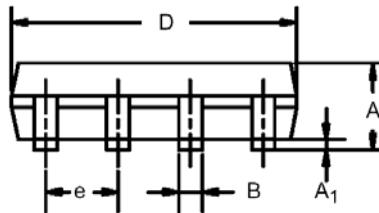
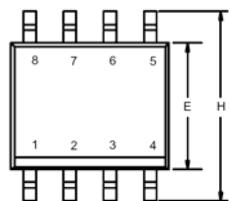
Single Pulse Power



Normalized Thermal Transient Impedance, Junction-to-Ambient

Package Information

SO-8: 8LEAD



Dim	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A₁	0.10	0.20	0.004	0.008
B	0.35	0.51	0.014	0.020
C	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°

